

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	6	("5997651" "6140256" "5352294" "5788778" "5518593" "5983906").pn.	USPAT	OR	OFF	2005/06/13 15:50
S2	0	U5-4,944,650 U5-5,352,294 U5-5,380,566 U5-5,518,593 U5-5,582,866 U5-5,677,824 U5-5,788,778 U5-5,823,736 U5-5,997,651 U5-6,002,840 U5-6,109,677 U5-6,183,189 U5-6,140,256 U5-6,305,677	USPAT	OR	OFF	2005/06/13 15:50
S3	14	("4,944,650" "5,352,294" "5,380,566" "5,518,593" "5,582,866" "5,677,824" "5,788,778" "5,823,736" "5,997,651" "6,002,840" "6,109,677" "6,183,189" "6,140,256" "6,305,677").pn.	USPAT	OR	OFF	2005/06/13 16:21
S4	15	S1 S3	USPAT	OR	OFF	2005/06/13 15:53
S5	0	S4 and bow\$3	USPAT	OR	OFF	2005/06/13 15:53
S6	1	S4 and bend\$3	USPAT	OR	OFF	2005/06/13 15:57
S7	2	dechuck\$3 with bow\$3	USPAT	OR	OFF	2005/06/13 15:58
S8	4095	pin\$1 with bow\$3	USPAT	OR	OFF	2005/06/13 15:59
S9	68	S8 and chuck\$3	USPAT	OR	OFF	2005/06/13 16:03
S10	1	S3 and warp\$3	USPAT	OR	OFF	2005/06/13 16:03
S11	243	269/13 "269\54.2-.5"	USPAT	OR	OFF	2005/06/13 16:21
S12	0	S11 and (pin\$1 with (warp\$3 bend\$3))	USPAT	OR	OFF	2005/06/13 16:24
S13	4331	118/500 118/728	USPAT	OR	OFF	2005/06/13 16:23
S14	29	S13 and (pin\$1 with (warp\$3 bend\$3))	USPAT	OR	OFF	2005/06/13 16:24
S15	1	"6140256".pn.	USPAT	OR	OFF	2005/06/13 16:29
S16	6392	(wafer semiconductor) with (bend\$3 bow\$3 warp\$3)	USPAT	OR	OFF	2005/11/30 10:12
S17	991	(stem\$1 element\$1 support\$1 peg\$1 pin\$1 rod\$1) with S16	USPAT	OR	OFF	2005/11/30 10:12
S18	991	(stem\$1 element\$1 support\$1 peg\$1 pin\$1 rod\$1) with S16	US-PGPUB; USPAT	OR	OFF	2005/11/30 10:12
S19	9894	(wafer semiconductor) with (bend\$3 bow\$3 warp\$3)	US-PGPUB; USPAT	OR	OFF	2005/11/30 11:35
S20	1506	(stem\$1 element\$1 support\$1 peg\$1 pin\$1 rod\$1) with S19	US-PGPUB; USPAT	OR	OFF	2005/11/30 10:57
S21	7895	(wafer semiconductor) with (bend\$3 bow\$3 warp\$3)	EPO; JPO; DERWENT	OR	OFF	2005/11/30 11:57
S22	0	(stem\$1 element\$1 support\$1 peg\$1 pin\$1 rod\$1) with S19	EPO; JPO; DERWENT	OR	OFF	2005/11/30 10:58
S23	1425	(stem\$1 element\$1 support\$1 peg\$1 pin\$1 rod\$1) with S21	EPO; JPO; DERWENT	OR	OFF	2005/11/30 11:11

S24	35	(shang-quanyuan william-harshbarger green-robert).in.	EPO; JPO; DERWENT	OR	OFF	2005/11/30 11:14
S25	83	(shang-quanyuan william-harshbarger green-robert).in.	US-PGPUB; USPAT	OR	OFF	2005/11/30 11:30
S26	10	shimizu-ichiro.in.	US-PGPUB; USPAT	OR	OFF	2005/11/30 11:19
S27	4	("20020019074"   "4556362"   "5098501").PN. OR ("6709543").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/30 11:21
S28	5	("20020129899"   "5987725"   "6561743"   "6658718"   "6709543").PN. OR ("6896762").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/30 11:24
S29	3	("20020019074"   "4556362"   "5098501").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/30 11:24
S30	27	("3377653"   "3893644").PN. OR ("4556362").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/30 11:26
S31	40	"3893644" "4984953" "5743695"	US-PGPUB; USPAT	OR	OFF	2005/11/30 11:34
S32	5685	118/500 118/728 414/416/01 206/832 269/13 (269/54.2-54.5).cccls.	US-PGPUB; USPAT	OR	OFF	2005/11/30 11:35
S33	344	S32 and S19	US-PGPUB; USPAT	OR	OFF	2005/11/30 11:51
S34	5	("5146481" "5916370" "5828810" "6072162" "3895216").pn.	US-PGPUB; USPAT	OR	OFF	2005/11/30 11:52
S35	5	"05102044" "6260426" "11329941"	EPO; JPO; DERWENT	OR	OFF	2005/11/30 11:53
S36	5	"09471759"	US-PGPUB; USPAT	OR	OFF	2005/11/30 11:54
S37	291	paik-\$.in.	US-PGPUB; USPAT	OR	OFF	2005/11/30 11:54
S38	50	S37 and (wafer semiconductor)	US-PGPUB; USPAT	OR	OFF	2005/11/30 11:56
S39	517	(applied materials).as. and (bend\$3 bow\$3 warp\$3) with (wafer substrate semiconductor article)	US-PGPUB; USPAT	OR	OFF	2005/11/30 11:58